Lattice Semiconductor Corporation - LFE2M20E-6FN484I Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	2375
Number of Logic Elements/Cells	19000
Total RAM Bits	1246208
Number of I/O	304
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m20e-6fn484i

Delay Locked Loops (DLL)

In addition to PLLs, the LatticeECP2/M family of devices has two DLLs per device.

CLKI is the input frequency (generated either from the pin or routing) for the DLL. CLKI feeds into the output muxes block to bypass the DLL, directly to the DELAY CHAIN block and (directly or through divider circuit) to the reference input of the Phase Frequency Detector (PFD) input mux. The reference signal for the PFD can also be generated from the Delay Chain and CLKFB signals. The feedback input to the PFD is generated from the CLKFB pin, CLKI or from tapped signal from the Delay chain.

The PFD produces a binary number proportional to the phase and frequency difference between the reference and feedback signals. This binary output of the PFD is fed into a Arithmetic Logic Unit (ALU). Based on these inputs, the ALU determines the correct digital control codes to send to the delay chain in order to better match the reference and feedback signals. This digital code from the ALU is also transmitted via the Digital Control bus (DCNTL) bus to its associated DLLDELA delay block. The ALUHOLD input allows the user to suspend the ALU output at its current value. The UDDCNTL signal allows the user to latch the current value on the DCNTL bus.

The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. Both the CLKOS and CLKOP outputs are available with optional duty cycle correction. Divide by two and divide by four frequencies are available at CLKOS. The LOCK output signal is asserted when the DLL is locked. Figure 2-6 shows the DLL block diagram and Table 2-5 provides a description of the DLL inputs and outputs.

The user can configure the DLL for many common functions such as time reference delay mode and clock injection removal mode. Lattice provides primitives in its design tools for these functions. For more information about the DLL, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-6. Delay Locked Loop Diagram (DLL)

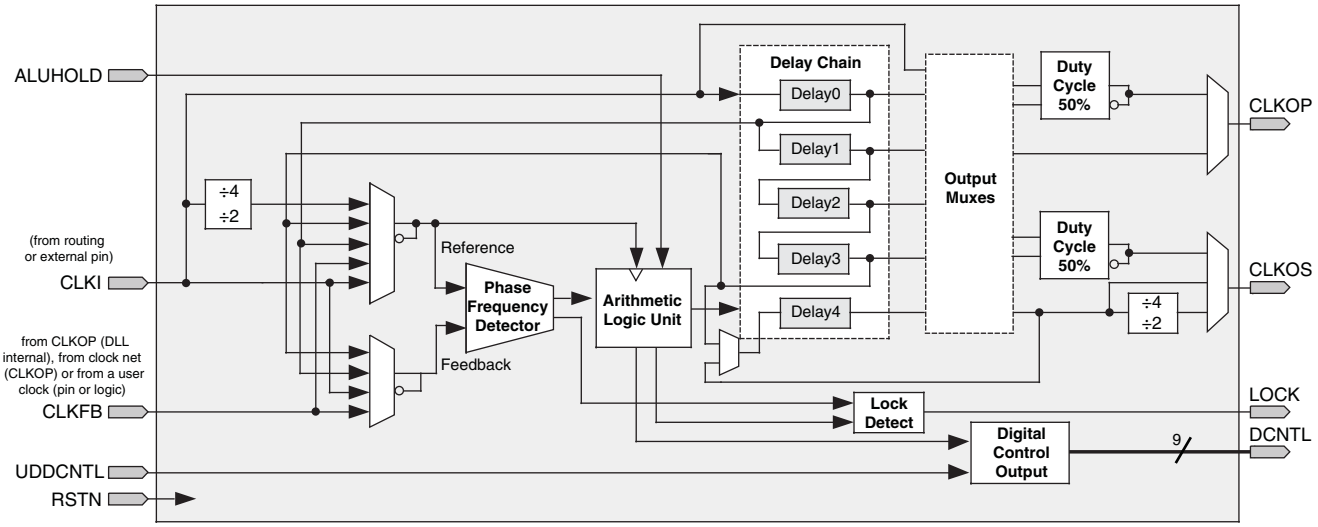


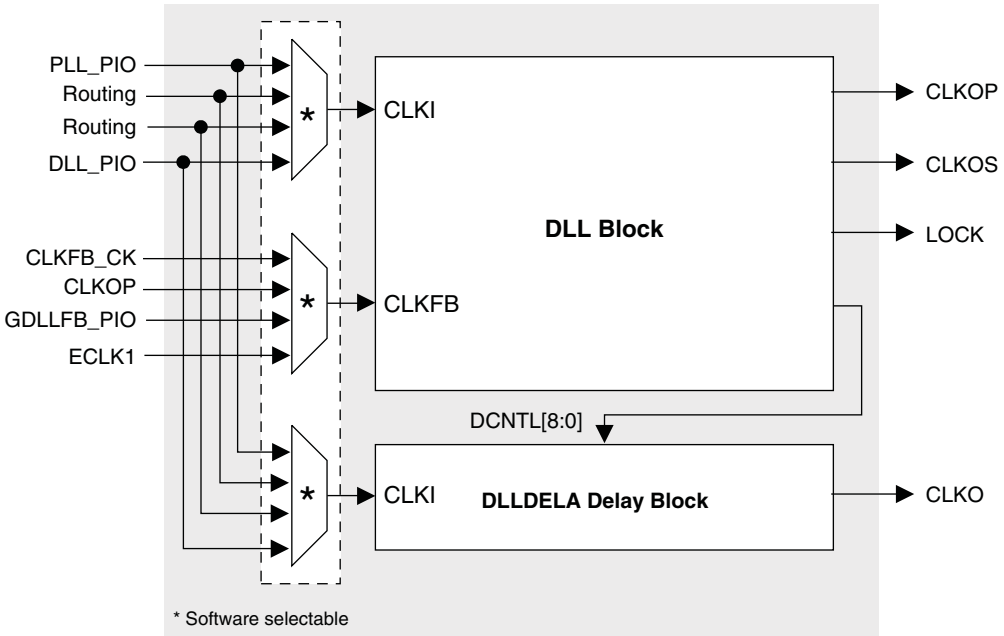
Table 2-5. DLL Signals

Signal	I/O	Description
CLKI	I	Clock input from external pin or routing
CLKFB	I	DLL feed input from DLL output, clock net, routing or external pin
RSTN	I	Active low synchronous reset
ALUHOLD	I	Active high freezes the ALU
UDDCNTL	I	Synchronous enable signal (hold high for two cycles) from routing
DCNTL[8:0]	O	Encoded digital control signals for PIC INDEL and slave delay calibration
CLKOP	O	The primary clock output
CLKOS	O	The secondary clock output with fine phase shift and/or division by 2 or by 4
LOCK	O	Active high phase lock indicator

DLLDELA Delay Block

Closely associated with each DLL is a DLLDELA block. This is a delay block consisting of a delay line with taps and a selection scheme that selects one of the taps. The DCNTL[8:0] bus controls the delay of the CLKO signal. Typically this is the delay setting that the DLL uses to achieve phase alignment. This results in the delay providing a calibrated 90° phase shift that is useful in centering a clock in the middle of a data cycle for source synchronous data. The CLKO signal feeds the edge clock network. Figure 2-7 shows the connections between the DLL block and the DLLDELA delay block. For more information, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-7. DLLDELA Delay Block



PLL/DLL Cascading

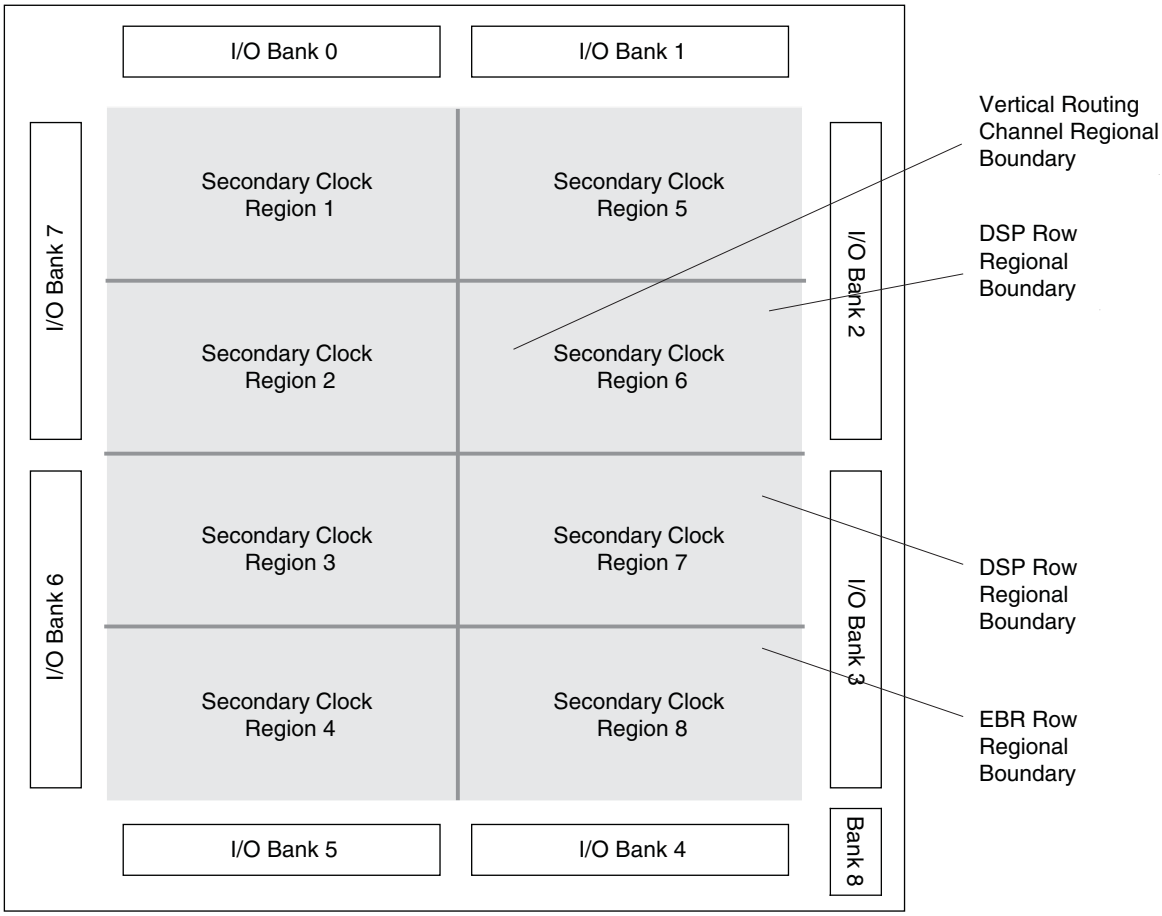
LatticeECP2/M devices have been designed to allow certain combinations of PLL (GPLL and SPLL) and DLL cascading. The allowable combinations are:

- PLL to PLL supported
- PLL to DLL supported

this special vertical routing channel and the eight secondary clock regions for the ECP2-50. LatticeECP2 devices have four secondary clocks (SC0 to SC3) which are distrubed to every region.

The secondary clock muxes are located in the center of the device. Figure 2-16 shows the mux structure of the secondary clock routing. Secondary clocks SC0 to SC3 are used for clock and control and SC4 to SC7 are used for high fan-out signals.

Figure 2-15. Secondary Clock Regions ECP2-50



sysMEM Memory

LatticeECP2/M devices contains a number of sysMEM Embedded Block RAM (EBR). The EBR consists of an 18-Kbit RAM with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6. FIFOs can be implemented in sysMEM EBR blocks by implementing support logic with PFUs. The EBR block facilitates parity checking by supporting an optional parity bit for each data byte. EBR blocks provide byte-enable support for configurations with18-bit and 36-bit data widths.

Table 2-6. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1, and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Memory Cascading

Larger and deeper blocks of RAM can be created using EBR sysMEM Blocks. Typically, the Lattice design tools cascade memory transparently, based on specific design inputs.

Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

EBR memory supports two forms of write behavior for single port or dual port operation:

1. Normal – Data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.

LatticeECP2/M DSP Performance

Table 2-11 lists the maximum performance in millions of MAC operations per second (MMAC) for each member of the LatticeECP2/M family.

Table 2-11. DSP Performance

Device	DSP Block	DSP Performance GMAC
ECP2-6	3	3.9
ECP2-12	6	7.8
ECP2-20	7	9.1
ECP2-35	8	10.4
ECP2-50	18	23.4
ECP2-70	22	28.6
ECP2M20	6	7.8
ECP2M35	8	10.4
ECP2M50	22	28.6
ECP2M70	24	31.2
ECP2M100	42	54.6

For further information about the sysDSP block, please see the list of additional technical information at the end of this data sheet.

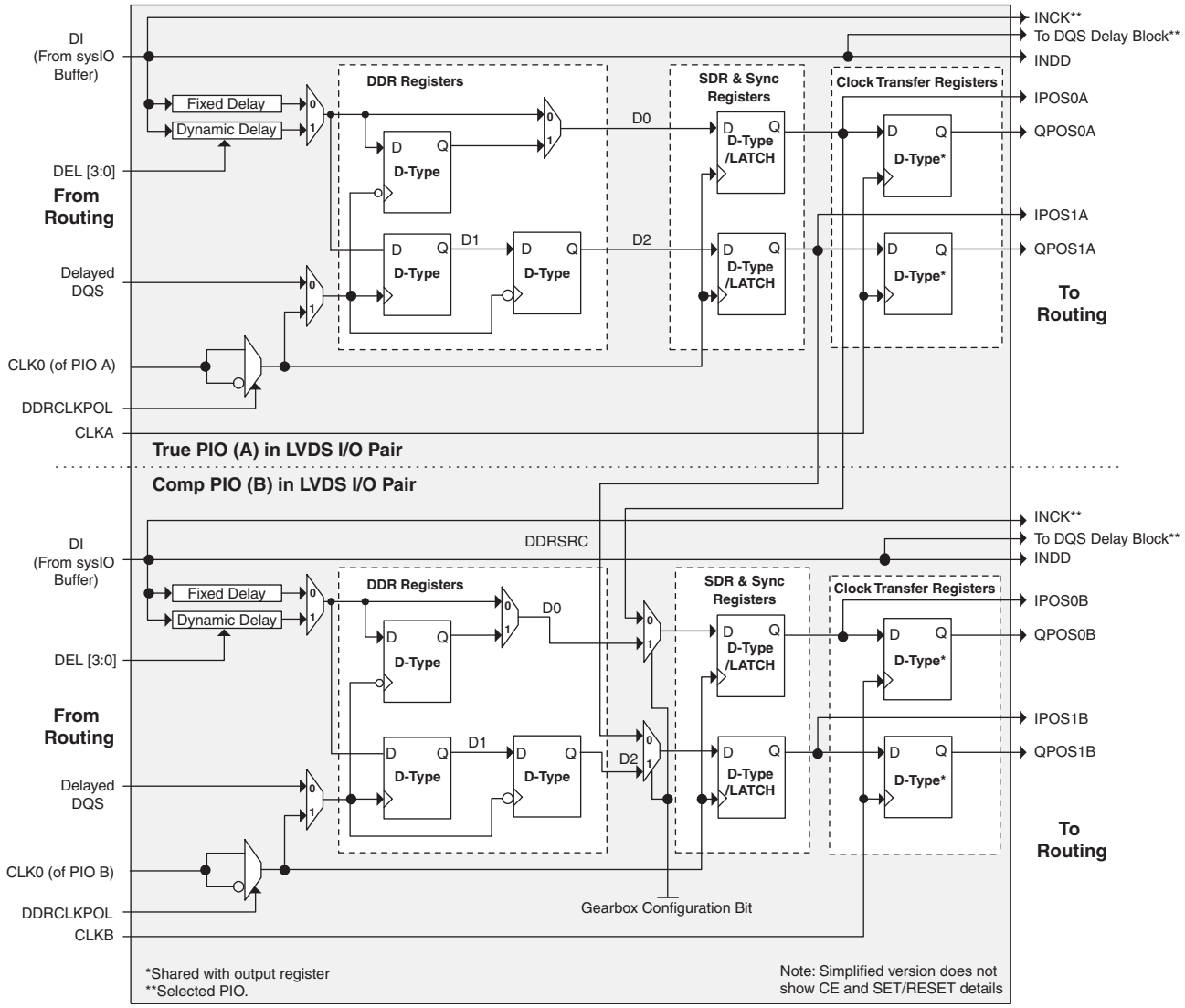
Programmable I/O Cells (PIC)

Each PIC contains two PIOs connected to their respective sysI/O buffers as shown in Figure 2-28. The PIO Block supplies the output data (DO) and the tri-state control signal (TO) to the sysI/O buffer and receives input from the buffer. Table 2-12 provides the PIO signal list.

By combining input blocks of the complementary PIOs and sharing some registers from output blocks, a gearbox function can be implemented, which takes a double data rate signal applied to PIOA and converts it as four data streams, IPOS0A, IPOS1A, IPOS0B and IPOS1B. Figure 2-29 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

The signal DDRCLKPOL controls the polarity of the clock used in the synchronization registers. It ensures adequate timing when data is transferred from the DQS to the system clock domain. For further information about this topic, see the DDR Memory section of this data sheet.

Figure 2-29. Input Register Block for Left, Right and Bottom Edges



MLVDS

The LatticeECP2/M devices support the differential MLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The MLVDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-5 is one possible solution for MLVDS standard implementation. Resistor values in Figure 3-5 are industry standard values for 1% resistors.

Figure 3-5. MLVDS (Multipoint Low Voltage Differential Signaling)

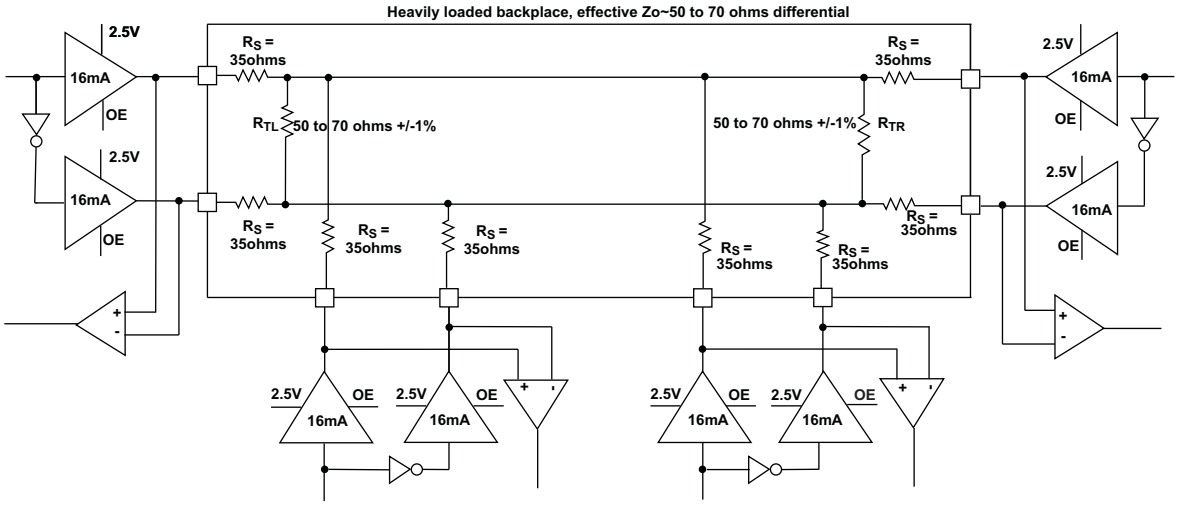


Table 3-6. MLVDS DC Conditions[1]

Parameter	Description	Typical		Units
		Zo=50Ω	Zo=70Ω	
V_{CCIO}	Output Driver Supply (+/-5%)	2.50	2.50	V
Z_{OUT}	Driver Impedance	10.00	10.00	Ω
R_S	Driver Series Resistor (+/-1%)	35.00	35.00	Ω
R_{TL}	Driver Parallel Resistor (+/-1%)	50.00	70.00	Ω
R_{TR}	Receiver Termination (+/-1%)	50.00	70.00	Ω
V_{OH}	Output High Voltage	1.52	1.60	V
V_{OL}	Output Low Voltage	0.98	0.90	V
V_{OD}	Output Differential Voltage	0.54	0.70	V
V_{CM}	Output Common Mode Voltage	1.25	1.25	V
I_{DC}	DC Output Current	21.74	20.00	mA

1. For input buffer, see LVDS table.

For further information about LVPECL, RSDS, MLVDS, BLVDS and other differential interfaces please see the list of additional technical information at the end of this data sheet.

Typical Building Block Function Performance[1]

Pin-to-Pin Performance (LVCMOS25 12mA Drive)

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	3.8	ns
32-bit Decoder	4.5	ns
64-bit Decoder	5.0	ns
4:1 MUX	3.2	ns
8:1 MUX	3.4	ns
16:1 MUX	3.5	ns
32:1 MUX	4.0	ns

1. These timing numbers were generated using the ispLEVER 8.0 design tool. Exact performance may vary with device and tool version. The tool uses internal parameters that have been characterized but are not tested on every device.

Register-to-Register Performance

Function	-7 Timing	Units
Basic Functions		
16-bit Decoder	599	MHz
32-bit Decoder	542	MHz
64-bit Decoder	417	MHz
4:1 MUX	847	MHz
8:1 MUX	803	MHz
16:1 MUX	660	MHz
32:1 MUX	577	MHz
8-bit Adder	591	MHz
16-bit Adder	500	MHz
64-bit Adder	306	MHz
16-bit Counter	488	MHz
32-bit Counter	378	MHz
64-bit Counter	260	MHz
64-bit Accumulator	253	MHz
Embedded Memory Functions		
512x36 Single Port RAM, EBR Output Registers	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, EBR Output Registers)	370	MHz
1024x18 True-Dual Port RAM (Write Through or Normal, PLC Output Registers)	280	MHz
Distributed Memory Functions		
16x4 Pseudo-Dual Port RAM (One PFU)	819	MHz
32x4 Pseudo-Dual Port RAM	521	MHz
64x8 Pseudo-Dual Port RAM	435	MHz
DSP Functions		
18x18 Multiplier (All Registers)	420	MHz
9x9 Multiplier (All Registers)	420	MHz

LatticeECP2/M External Switching Characteristics[9] (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{DIBSPI}	Data Invalid Before Clock (Transmit)	ECP2-20	—	280	—	280	—	280	ps
		ECP2-35	—	280	—	280	—	280	ps
		ECP2-50	—	280	—	280	—	280	ps
		ECP2-70	—	280	—	280	—	280	ps
		ECP2M20	—	230	—	230	—	230	ps
		ECP2M35	—	230	—	230	—	230	ps
		ECP2M50	—	230	—	230	—	230	ps
		ECP2M70	—	230	—	230	—	230	ps
		ECP2M100	—	230	—	230	—	230	ps
XGMII I/O Pin Parameters (312 Mbps)[5]									
$t_{SUXGMII}$	Data Setup Before Read Clock	ECP2/M	480	—	480	—	480	—	ps
t_{HXGMII}	Data Hold After Read Clock	ECP2/M	480	—	480	—	480	—	ps
$t_{DVBCKXGMII}$	Data Valid Before Clock	ECP2/M	960	—	960	—	960	—	ps
$t_{DVACKXGMII}$	Data Valid After Clock	ECP2/M	960	—	960	—	960	—	ps
Primary									
f_{MAX_PRI}[7]	Frequency for Primary Clock Tree	ECP2/M	—	420	—	357	—	311	MHz
t_{W_PRI}	Clock Pulse Width for Primary Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t_{SKEW_PRI}	Primary Clock Skew Within a Bank	ECP2/M	—	300	—	360	—	420	ps
Edge Clock									
f_{MAX_EDGE}[7]	Frequency for Edge Clock	ECP2/M	—	420	—	357	—	311	MHz
t_{W_EDGE}	Clock Pulse Width for Edge Clock	ECP2/M	0.95	—	1.19	—	2.00	—	ns
t_{SKEW_EDGE}	Edge Clock Skew Within an Edge of the Device	ECP2/M	—	300	—	360	—	420	ps

1. General timing numbers based on LVCMOS 2.5, 12mA, 0pf load.
2. DDR timing numbers based on SSTL25 for BGA packages only.
3. DDR2 timing numbers based on SSTL18 for BGA packages only.
4. SPI4.2 and SFI4 timing numbers based on LVDS25 for BGA packages only.
5. XGMII timing numbers based on HSTL class I. A corresponding left/right dedicated clock buffer is used when using the SPI4.2 interface to the left or right edge of the device. For SPI4.2 mode, the software tool will help in selecting the appropriate clock buffer.
6. IP will be used to support DDR and DDR2 memory data rates down to 95MHz. This approach uses a free-running clock and PFU register to sample the data instead of the hardwired DDR memory interface.
7. Using the LVDS I/O standard.
8. ECP2-6 and ECP2-12 do not support SPI4.2
9. The AC numbers do not apply to PCLK6 and PCLK7.
10. Applies to CLKOP only.
11. Please refer to TN1159, LatticeECP2/M Pin Assignment Recommendations for best performance.

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
t_{HCBDI}	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay[1]	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port[2]				
t_{CFGX}	INITN High to CCLK Low	—	1	µs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
46	NC	5			PB16B	5	BDQ15	C
47	GND	-			GND	-		
48	VCC				VCC	-		
49	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
50	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
51	GND	-			GND	-		
52	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
53	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
54	VCC	-			VCC	-		
55	PB14A	4	BDQ15	T	PB34A	4	BDQ33	T
56	PB14B	4	BDQ15	C	PB34B	4	BDQ33	C
57	PB16A	4	BDQ15	T	PB40A	4	BDQ42	T
58	PB16B	4	BDQ15	C	PB40B	4	BDQ42	C
59	PB18A	4	BDQ15	T	PB44A	4	BDQ42	T
60	PB18B	4	BDQ15	C	PB44B	4	BDQ42	C
61	GND	-			GND	-		
62	PB20A	4	BDQ24	T	PB48A	4	BDQ51	T
63	PB20B	4	BDQ24	C	PB48B	4	BDQ51	C
64	VCCIO4	4			VCCIO4	4		
65	PB22A	4	BDQ24	T	PB50A	4	BDQ51	T
66	PB22B	4	BDQ24	C	PB50B	4	BDQ51	C
67	PB24A	4	BDQS24	T	PB52A	4	BDQ51	T
68	PB24B	4	BDQ24	C	PB52B	4	BDQ51	C
69	PB26A	4	BDQ24	T	PB54A	4	BDQ51	T
70	PB26B	4	BDQ24	C	PB54B	4	BDQ51	C
71	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
72	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
73	CFG1	8			CFG1	8		
74	CFG2	8			CFG2	8		
75	PROGRAMN	8			PROGRAMN	8		
76	INITN	8			INITN	8		
77	CFG0	8			CFG0	8		
78	CCLK	8			CCLK	8		
79	DONE	8			DONE	8		
80	PR29A	8	D0/SPIFASTN		PR29A	8	D0/SPIFASTN	
81	GND	-			GND	-		
82	PR26A	8	D6		PR26A	8	D6	
83	VCC	-			VCC	-		
84	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
85	VCCIO8	8			VCCIO8	8		
86	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
87	PR24B	8	DOUT/CSON	C	PR24B	8	DOUT/CSON	C
88	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
89	VCCIO3	3			VCCIO3	3		
90	VCCAUX	-			VCCAUX	-		

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H16	NC	-			NC	-		
H20	NC	-			NC	-		
H18	NC	-			NC	-		
K6	NC	-			NC	-		
J16	NC	-			NC	-		
N18	VCC	-			VCC	-		
N6	VCC	-			VCC	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO2	-			GNDIO2	-		
L21	PR43B	2	RDQ41	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*
K22	PR43A	2	RDQ41	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*
M24	PR42B	2	RDQ41	C	PR55B	2	RDQ54	C
N23	PR42A	2	RDQ41	T	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2			VCCIO2	2		
K26	PR41B	2	RDQ41	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*
K25	PR41A	2	RDQS41	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*
M20	PR40B	2	RDQ41	C	PR53B	2	RDQ54	C
GND	GNDIO2	-			GNDIO2	-		
M19	PR40A	2	RDQ41	T	PR53A	2	RDQ54	T
L22	PR39B	2	RDQ41	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*
M22	PR39A	2	RDQ41	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*
K21	PR38B	2	RDQ41	C	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2			VCCIO2	2		
M21	PR38A	2	RDQ41	T	PR51A	2	RDQ54	T
K24	PR37B	2	RDQ41	C (LVDS)*	PR50B	2	RDQ54	C (LVDS)*
J24	PR37A	2	RDQ41	T (LVDS)*	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
VCCIO	VCCIO2	2			VCCIO2	2		
L20	VCCPLL	2			NC	-		
GND	GNDIO2	-			GNDIO2	-		
J26	PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
J25	PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
J23	PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
K23	PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
H26	PR24B	2	RDQ24	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*
H25	PR24A	2	RDQS24***	T (LVDS)*	PR37A	2	RDQS37***	T (LVDS)*
H24	PR23B	2	RDQ24	C	PR36B	2	RDQ37	C
GND	GNDIO2	-			GNDIO2	-		
H23	PR23A	2	RDQ24	T	PR36A	2	RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
G26	PR19B	2	RDQ16	C	PR32B	2	RDQ29	C
GND	GNDIO2	-			GNDIO2	-		
G25	PR19A	2	RDQ16	T	PR32A	2	RDQ29	T
F26	PR18B	2	RDQ16	C (LVDS)*	PR31B	2	RDQ29	C (LVDS)*
F25	PR18A	2	RDQ16	T (LVDS)*	PR31A	2	RDQ29	T (LVDS)*
K20	PR17B	2	RDQ16	C	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2			VCCIO2	2		
L19	PR17A	2	RDQ16	T	PR30A	2	RDQ29	T
E26	PR16B	2	RDQ16	C (LVDS)*	PR29B	2	RDQ29	C (LVDS)*
E25	PR16A	2	RDQS16	T (LVDS)*	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
J22	PR15B	2	RDQ16	C	PR28B	2	RDQ29	C
H22	PR15A	2	RDQ16	T	PR28A	2	RDQ29	T

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO1	-			GNDIO1	-		
C15	PT54B	1		C	PT63B	1		C
A15	PT54A	1		T	PT63A	1		T
A13	PT53B	1		C	PT62B	1		C
B13	PT53A	1		T	PT62A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H17	PT52B	1		C	PT61B	1		C
H15	PT52A	1		T	PT61A	1		T
D13	PT51B	1		C	PT60B	1		C
C14	PT51A	1		T	PT60A	1		T
GND	GNDIO1	-			GNDIO1	-		
G14	PT50B	1		C	PT59B	1		C
E14	PT50A	1		T	PT59A	1		T
A12	PT49B	1		C	PT58B	1		C
B12	PT49A	1		T	PT58A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F14	PT48B	1	PCLKC1_0	C	PT57B	1	PCLKC1_0	C
D14	PT48A	1	PCLKT1_0	T	PT57A	1	PCLKT1_0	T
H16	XRES	1			XRES	1		
H14	PT46B	0	PCLKC0_0	C	PT55B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
H13	PT46A	0	PCLKT0_0	T	PT55A	0	PCLKT0_0	T
A11	PT45B	0		C	PT54B	0		C
B11	PT45A	0		T	PT54A	0		T
C13	PT44B	0		C	PT53B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E13	PT44A	0		T	PT53A	0		T
D12	PT43B	0		C	PT52B	0		C
F13	PT43A	0		T	PT52A	0		T
A10	PT42B	0		C	PT51B	0		C
B10	PT42A	0		T	PT51A	0		T
C12	PT41B	0		C	PT50B	0		C
GND	GNDIO0	-			GNDIO0	-		
C10	PT41A	0		T	PT50A	0		T
G13	PT40B	0		C	PT49B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
H12	PT40A	0		T	PT49A	0		T
A9	PT39B	0		C	PT48B	0		C
B9	PT39A	0		T	PT48A	0		T
E12	PT38B	0		C	PT47B	0		C
G12	PT38A	0		T	PT47A	0		T
A8	PT37B	0		C	PT46B	0		C
B8	PT37A	0		T	PT46A	0		T
GND	GNDIO0	-			GNDIO0	-		
E11	PT36B	0		C	PT45B	0		C
C9	PT36A	0		T	PT45A	0		T

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C15	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
B15	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
C14	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A18	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
C18	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
B18	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
C17	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
B17	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
A16	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		
A17	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
C16	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
B14	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B13	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
A14	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
C13	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		
-	-	-			GNDIO1	-		
-	-	-			VCCIO1	1		
E17	PT46B	1		C	PT55B	1		C
D17	PT46A	1		T	PT55A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
F17	PT45B	1		C	PT54B	1		C
D16	PT45A	1		T	PT54A	1		T
F19	PT44B	1		C	PT53B	1		C
F18	PT44A	1		T	PT53A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
E16	PT43B	1		C	PT52B	1		C
D15	PT43A	1		T	PT52A	1		T
G18	PT42B	1		C	PT51B	1		C
E15	PT42A	1		T	PT51A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
G17	PT41B	1		C	PT50B	1		C
E14	PT41A	1		T	PT50A	1		T
D14	PT40B	1		C	PT49B	1		C
D13	PT40A	1		T	PT49A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F15	PT39B	1	VREF2_1	C	PT48B	1	VREF2_1	C
E12	PT39A	1	VREF1_1	T	PT48A	1	VREF1_1	T
H17	PT38B	1	PCLKC1_0	C	PT47B	1	PCLKC1_0	C
E13	PT38A	1	PCLKT1_0	T	PT47A	1	PCLKT1_0	T
C12	PT37B	0	PCLKC0_0	C	PT46B	0	PCLKC0_0	C
GNDIO	GNDIO0	-			GNDIO0	-		
G15	PT37A	0	PCLKT0_0	T	PT46A	0	PCLKT0_0	T
C11	PT36B	0	VREF2_0	C	PT45B	0	VREF2_0	C
F14	PT36A	0	VREF1_0	T	PT45A	0	VREF1_0	T

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
Y15	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
AA26	NC	-			NC	-		
AB10	PL73B	6	LDQ71	C (LVDS)*	NC	-		
AB11	NC	-			NC	-		
AB12	NC	-			NC	-		
AB13	NC	-			NC	-		
AB14	NC	-			NC	-		
AB15	NC	-			NC	-		
AB16	NC	-			NC	-		
AB17	NC	-			NC	-		
AB19	NC	-			NC	-		
AB20	NC	-			NC	-		
AB21	NC	-			NC	-		
AB9	PL73A	6	LDQ71	T (LVDS)*	NC	-		
AC10	PL74B	6	LDQ71	C	NC	-		
AC11	NC	-			NC	-		
AC21	NC	-			NC	-		
AC22	NC	-			NC	-		
AC8	PL70B	6	LDQ71	C	NC	-		
AC9	PL74A	6	LDQ71	T	NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD4	PL68A	6	LDQ71	T	NC	-		
AD5	PL68B	6	LDQ71	C	NC	-		
AD6	PL71A	6	LDQS71	T (LVDS)*	NC	-		
AD7	PL72A	6	LDQ71	T	NC	-		
AD8	PL72B	6	LDQ71	C	NC	-		
AE23	NC	-			NC	-		
AE5	PL69A	6	LDQ71	T (LVDS)*	NC	-		
AE6	PL70A	6	LDQ71	T	NC	-		
AE7	PL71B	6	LDQ71	C (LVDS)*	NC	-		
AF20	NC	-			NC	-		
AF23	NC	-			NC	-		
AF5	PL69B	6	LDQ71	C (LVDS)*	NC	-		
AG23	NC	-			NC	-		
AG26	NC	-			NC	-		
D10	PT10A	0		T	NC	-		
E10	PT9B	0		C	NC	-		
E11	PT10B	0		C	NC	-		
F10	PT9A	0		T	NC	-		
F20	NC	-			NC	-		
F23	NC	-			NC	-		
F8	PL6B	7	LDQ6	C (LVDS)*	NC	-		
G10	NC	-			NC	-		
G20	NC	-			NC	-		
G21	NC	-			NC	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
VCCIO	VCCIO3	3		
T22	PR69A	3	RDQ72	T
T29	PR68B	3	RDQ72	C (LVDS)*
T28	PR68A	3	RDQ72	T (LVDS)*
R23	PR66B	3	RLM4_SPLLC_FB_A/RDQ63	C
GNDIO	GNDIO3	-		
-	-	-		
R22	PR66A	3	RLM4_SPLLT_FB_A/RDQ63	T
P30	PR65B	3	RLM4_SPLLC_IN_A/RDQ63	C (LVDS)*
R29	PR65A	3	RLM4_SPLLT_IN_A/RDQ63	T (LVDS)*
T27	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3		
T26	PR64A	3	RDQ63	T
GNDIO	GNDIO3	-		
N30	PR61B	3	RDQ63	C (LVDS)*
N29	PR61A	3	RDQ63	T (LVDS)*
VCCIO	VCCIO3	3		
R27	PR60B	3	VREF2_3/RDQ63	C
R28	PR60A	3	VREF1_3/RDQ63	T
P29	PR59B	3	PCLKC3_0/RDQ63	C (LVDS)*
P28	PR59A	3	PCLKT3_0/RDQ63	T (LVDS)*
M30	PR57B	2	PCLKC2_0/RDQ54	C
M29	PR57A	2	PCLKT2_0/RDQ54	T
GNDIO	GNDIO2	-		
P23	PR56B	2	RDQ54	C (LVDS)*
P24	PR56A	2	RDQ54	T (LVDS)*
R26	PR55B	2	RDQ54	C
P27	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2		
P25	PR54B	2	RDQ54	C (LVDS)*
P26	PR54A	2	RDQS54	T (LVDS)*
K30	PR53B	2	RDQ54	C
GNDIO	GNDIO2	-		
K29	PR53A	2	RDQ54	T
N22	PR52B	2	RDQ54	C (LVDS)*
P22	PR52A	2	RDQ54	T (LVDS)*
J30	PR51B	2	RUM3_SPLLC_FB_A/RDQ54	C
VCCIO	VCCIO2	2		
J29	PR51A	2	RUM3_SPLLT_FB_A/RDQ54	T
N24	PR50B	2	RUM3_SPLLC_IN_A/RDQ54	C (LVDS)*
N23	PR50A	2	RUM3_SPLLT_IN_A/RDQ54	T (LVDS)*
N25	PR48B	2	RDQ45	C
N26	PR48A	2	RDQ45	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AA25	PR74B	3	RDQ73	C	PR82B	3	RDQ81	C
VCCIO	VCCIO3	3			VCCIO3	3		
AC24	PR74A	3	RDQ73	T	PR82A	3	RDQ81	T
AC33	PR73B	3	RDQ73	C (LVDS)*	PR81B	3	RDQ81	C (LVDS)*
AC34	PR73A	3	RDQS73	T (LVDS)*	PR81A	3	RDQS81	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
AB24	PR72B	3	RDQ73	C	PR80B	3	RDQ81	C
Y26	PR72A	3	RDQ73	T	PR80A	3	RDQ81	T
AB33	PR71B	3	RDQ73	C (LVDS)*	PR79B	3	RDQ81	C (LVDS)*
AB34	PR71A	3	RDQ73	T (LVDS)*	PR79A	3	RDQ81	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO3	3		
Y27	PR70B	3	RDQ73	C	PR78B	3	RDQ81	C
AB29	PR70A	3	RDQ73	T	PR78A	3	RDQ81	T
AA34	PR69B	3	RDQ73	C (LVDS)*	PR77B	3	RDQ81	C (LVDS)*
AA33	PR69A	3	RDQ73	T (LVDS)*	PR77A	3	RDQ81	T (LVDS)*
AA31	PR67B	3	RDQ64	C	PR75B	3	RDQ72	C
AA32	PR67A	3	RDQ64	T	PR75A	3	RDQ72	T
GNDIO	GNDIO3	-			GNDIO3	-		
AA28	PR66B	3	RDQ64	C (LVDS)*	PR74B	3	RDQ72	C (LVDS)*
AA29	PR66A	3	RDQ64	T (LVDS)*	PR74A	3	RDQ72	T (LVDS)*
AA30	PR65B	3	RDQ64	C	PR73B	3	RDQ72	C
AB30	PR65A	3	RDQ64	T	PR73A	3	RDQ72	T
VCCIO	VCCIO3	3			VCCIO3	3		
Y28	PR64B	3	RDQ64	C (LVDS)*	PR72B	3	RDQ72	C (LVDS)*
Y29	PR64A	3	RDQS64	T (LVDS)*	PR72A	3	RDQS72	T (LVDS)*
AA24	PR63B	3	RDQ64	C	PR71B	3	RDQ72	C
GNDIO	GNDIO3	-			GNDIO3	-		
Y25	PR63A	3	RDQ64	T	PR71A	3	RDQ72	T
Y31	PR62B	3	RDQ64	C (LVDS)*	PR70B	3	RDQ72	C (LVDS)*
Y30	PR62A	3	RDQ64	T (LVDS)*	PR70A	3	RDQ72	T (LVDS)*
Y24	PR61B	3	RDQ64	C	PR69B	3	RDQ72	C
VCCIO	VCCIO3	3			VCCIO3	3		
W25	PR61A	3	RDQ64	T	PR69A	3	RDQ72	T
Y33	PR60B	3	RDQ64	C (LVDS)*	PR68B	3	RDQ72	C (LVDS)*
Y34	PR60A	3	RDQ64	T (LVDS)*	PR68A	3	RDQ72	T (LVDS)*
W28	PR58B	3	RLM3_SPLLC_FB_A/RDQ55	C	PR66B	3	RLM4_SPLLC_FB_A/RDQ63	C
GNDIO	GNDIO3	-			GNDIO3	-		
V26	PR58A	3	RLM3_SPLLT_FB_A/RDQ55	T	PR66A	3	RLM4_SPLLT_FB_A/RDQ63	T
V28	PR57B	3	RLM3_SPLLC_IN_A/RDQ55	C (LVDS)*	PR65B	3	RLM4_SPLLC_IN_A/RDQ63	C (LVDS)*
V27	PR57A	3	RLM3_SPLLT_IN_A/RDQ55	T (LVDS)*	PR65A	3	RLM4_SPLLT_IN_A/RDQ63	T (LVDS)*
V25	PR56B	3	RDQ55	C	PR64B	3	RDQ63	C
VCCIO	VCCIO3	3			VCCIO3	3		
W24	PR56A	3	RDQ55	T	PR64A	3	RDQ63	T
W33	PR55B	3	RDQ55	C (LVDS)*	PR63B	3	RDQ63	C (LVDS)*
W34	PR55A	3	RDQS55	T (LVDS)*	PR63A	3	RDQS63	T (LVDS)*
GNDIO	GNDIO3	-			GNDIO3	-		
V24	PR54B	3	RDQ55	C	PR62B	3	RDQ63	C
U26	PR54A	3	RDQ55	T	PR62A	3	RDQ63	T
W29	PR53B	3	RDQ55	C (LVDS)*	PR61B	3	RDQ63	C (LVDS)*

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
H33	PR14B	2	RDQ15	C	PR14B	2	RDQ15	C
GNDIO	GNDIO2	-			GNDIO2	-		
H34	PR14A	2	RDQ15	T	PR14A	2	RDQ15	T
J30	PR13B	2	RDQ15	C (LVDS)*	PR13B	2	RDQ15	C (LVDS)*
J29	PR13A	2	RDQ15	T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
J27	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C (LVDS)*
J28	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
H31	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-			GNDIO2	-		
H32	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2			VCCIO2	2		
H30	XRES	1			XRES	1		
B33	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
C33	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B34	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
C32	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
B32	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A33	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
C34	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
A32	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
B31	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
A31	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
D32	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A30	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
B30	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
C31	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
D31	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
C30	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
E29	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
E30	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D30	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
D29	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
C29	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T
D27	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
C28	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
B29	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A29	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
E28	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
A28	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
B28	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
A27	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
D26	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		
A26	URC_SQ_HDOUTP3	12		T	URC_SQ_HDOUTP3	12		T
B27	URC_SQ_VCCTX3	12			URC_SQ_VCCTX3	12		
C27	URC_SQ_HDINN3	12		C	URC_SQ_HDINN3	12		C
B26	URC_SQ_VCCIB3	12			URC_SQ_VCCIB3	12		
C26	URC_SQ_HDINP3	12		T	URC_SQ_HDINP3	12		T
D28	URC_SQ_VCCRX3	12			URC_SQ_VCCRX3	12		

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M100E-5FN1152I	520	1.2V	-5	Lead-Free fpBGA	1152	Ind	100
LFE2M100E-6FN1152I	520	1.2V	-6	Lead-Free fpBGA	1152	Ind	100
LFE2M100E-5FN900I	416	1.2V	-5	Lead-Free fpBGA	900	Ind	100
LFE2M100E-6FN900I	416	1.2V	-6	Lead-Free fpBGA	900	Ind	100

LatticeECP2M S-Series Devices, Conventional Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20SE-5F484C	304	1.2V	-5	fpBGA	484	Com	20
LFE2M20SE-6F484C	304	1.2V	-6	fpBGA	484	Com	20
LFE2M20SE-7F484C	304	1.2V	-7	fpBGA	484	Com	20
LFE2M20SE-5F256C	140	1.2V	-5	fpBGA	256	Com	20
LFE2M20SE-6F256C	140	1.2V	-6	fpBGA	256	Com	20
LFE2M20SE-7F256C	140	1.2V	-7	fpBGA	256	Com	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35SE-5F672C	410	1.2V	-5	fpBGA	672	Com	35
LFE2M35SE-6F672C	410	1.2V	-6	fpBGA	672	Com	35
LFE2M35SE-7F672C	410	1.2V	-7	fpBGA	672	Com	35
LFE2M35SE-5F484C	303	1.2V	-5	fpBGA	484	Com	35
LFE2M35SE-6F484C	303	1.2V	-6	fpBGA	484	Com	35
LFE2M35SE-7F484C	303	1.2V	-7	fpBGA	484	Com	35
LFE2M35SE-5F256C	140	1.2V	-5	fpBGA	256	Com	35
LFE2M35SE-6F256C	140	1.2V	-6	fpBGA	256	Com	35
LFE2M35SE-7F256C	140	1.2V	-7	fpBGA	256	Com	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50SE-5F900C	410	1.2V	-5	fpBGA	900	Com	50
LFE2M50SE-6F900C	410	1.2V	-6	fpBGA	900	Com	50
LFE2M50SE-7F900C	410	1.2V	-7	fpBGA	900	Com	50
LFE2M50SE-5F672C	372	1.2V	-5	fpBGA	672	Com	50
LFE2M50SE-6F672C	372	1.2V	-6	fpBGA	672	Com	50
LFE2M50SE-7F672C	372	1.2V	-7	fpBGA	672	Com	50
LFE2M50SE-5F484C	270	1.2V	-5	fpBGA	484	Com	50
LFE2M50SE-6F484C	270	1.2V	-6	fpBGA	484	Com	50
LFE2M50SE-7F484C	270	1.2V	-7	fpBGA	484	Com	50